

700V Silicon N-channel Power MOSFET

Description

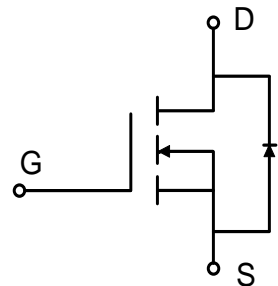
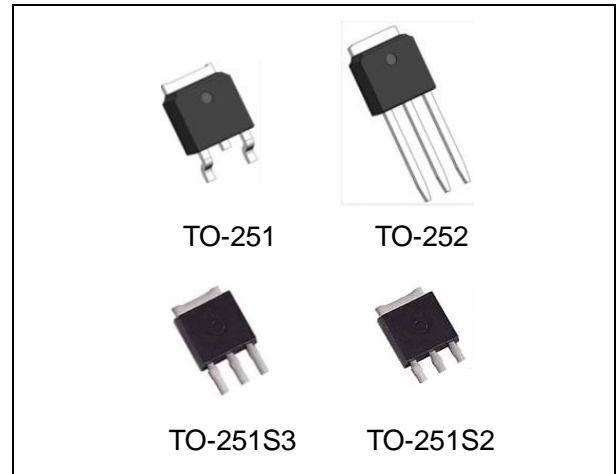
WMOSTM DM, the silicon N-channel enhanced VDMOSFETs, is obtained by the self-aligned planar technology which reduce the conduction loss, improve switching performance and enhance the avalanche energy. The transistor can be used in various power switching circuit for system miniaturization and higher efficiency.

Features

- Fast switching
- Typ. $R_{DS(on)} = 1.35\Omega$
- Low gate charge (Typ. $Q_g = 21.8nC$)
- Typ. $C_{rss} = 8.2pF$
- 100% UIS tested

Applications

LED Lighting, Charger, Adapter, PC, LCD TV, Server



Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-source voltage	V_{DSS}	700	V
Continuous drain current ($T_C = 25^\circ C$)	I_D	6	A
($T_C = 100^\circ C$)		3.79	A
Pulsed drain current ¹⁾	I_{DM}	24	A
Gate-source voltage	V_{GS}	± 30	V
Avalanche energy, single pulse ²⁾	E_{AS}	463	mJ
Power dissipation ($T_C = 25^\circ C$)	P_D	128	W
- Derate above $25^\circ C$		1.02	W/ $^\circ C$
Operating and storage temperature range	T_J, T_{STG}	-55 to +150	$^\circ C$
Continuous diode forward current	I_S	6	A
Diode pulse current	$I_{S,pulse}$	24	A

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal resistance, junction-to-case	$R_{\theta JC}$	0.98	$^\circ C/W$
Thermal resistance, junction-to-ambient	$R_{\theta JA}$	62.0	$^\circ C/W$

Electrical Characteristics $T_c = 25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static characteristics						
Drain-source breakdown voltage	BV_{DSS}	$V_{GS}=0\text{ V}, I_D=0.25\text{ mA}$	700	-	-	V
Gate threshold voltage	$V_{GS(th)}^{3)}$	$V_{DS}=V_{GS}, I_D=0.25\text{ mA}$	2	-	4	V
Drain cut-off current	I_{DSS}	$V_{DS}=700\text{ V}, V_{GS}=0\text{ V}$	-	-	1	μA
Gate leakage current, forward	I_{GSSF}	$V_{GS}=30\text{ V}, V_{DS}=0\text{ V}$	-	-	100	nA
Gate leakage current, reverse	I_{GSSR}	$V_{GS}=-30\text{ V}, V_{DS}=0\text{ V}$	-	-	-100	nA
Drain-source on-state resistance	$R_{DS(on)}^{3)}$	$V_{GS}=10\text{ V}, I_D=3\text{ A}$	-	1.35	1.7	Ω
Dynamic characteristics						
Input capacitance	C_{iss}	$V_{DS}=25\text{ V}, V_{GS}=0\text{ V},$ $f=1\text{ MHz}$	-	770	-	pF
Output capacitance	C_{oss}		-	90	-	
Reverse transfer capacitance	C_{rss}		-	8.2	-	
Turn-on delay time	$t_{d(on)}$	$V_{DD}=350\text{ V}, I_D=6\text{ A}$ $R_G=25\Omega, V_{GS}=10\text{ V}$	-	14.92	-	ns
Rise time	t_r		-	29.52	-	
Turn-off delay time	$t_{d(off)}$		-	52.2	-	
Fall time	t_f		-	30.2	-	
Gate charge characteristics						
Gate to source charge	Q_{gs}	$V_{DD}=560\text{ V}, I_D=6\text{ A},$ $V_{GS}=0\text{ to }10\text{ V}$	-	5.6	-	nC
Gate to drain charge	Q_{gd}		-	10.1	-	
Gate charge total	Q_g		-	21.8	-	
Reverse diode characteristics						
Diode forward voltage	V_{SD}	$V_{GS}=0\text{ V}, I_F=6\text{ A}$	-	-	1.4	V
Reverse recovery time	t_{rr}	$I_F=6\text{ A}, dI_F/dt=100\text{ A}/\mu\text{s}$	-	465	-	ns
Reverse recovery charge	Q_{rr}	$V_{GS}=0\text{ V}$	-	3.0	-	μC

Notes:

1. Repetitive rating: pulse width limited by maximum junction temperature
2. $I_{AS}=5\text{ A}, V_{DD}=50\text{ V}, R_G=25\Omega$, starting $T_J = 25^\circ\text{C}$
3. Pulse test: pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.

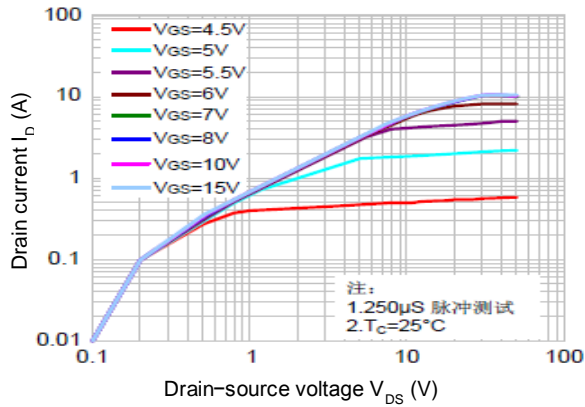


Figure 1. On-Region Characteristics

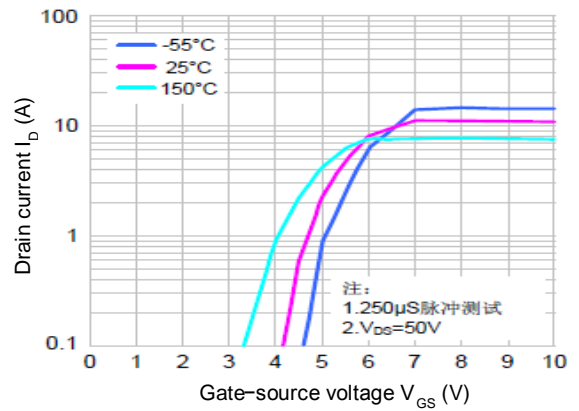


Figure 2. Transfer Characteristics

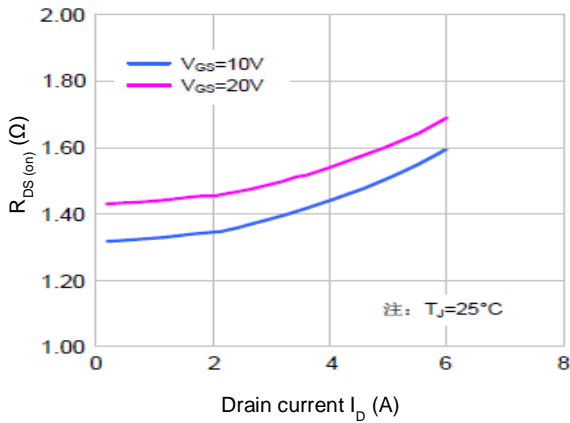


Figure 3. On-Resistance Variation vs. Drain Current

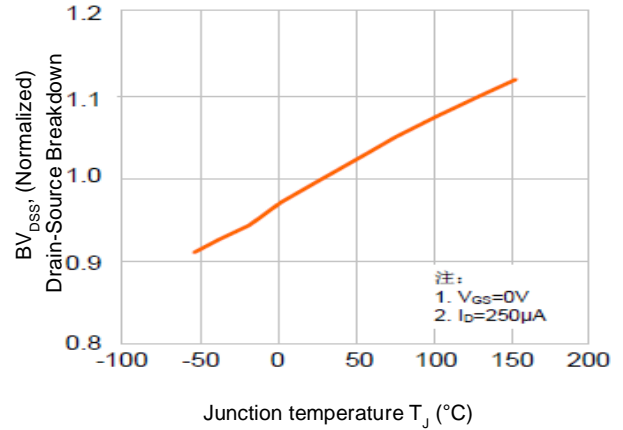


Figure 4. Breakdown Voltage vs. Temperature

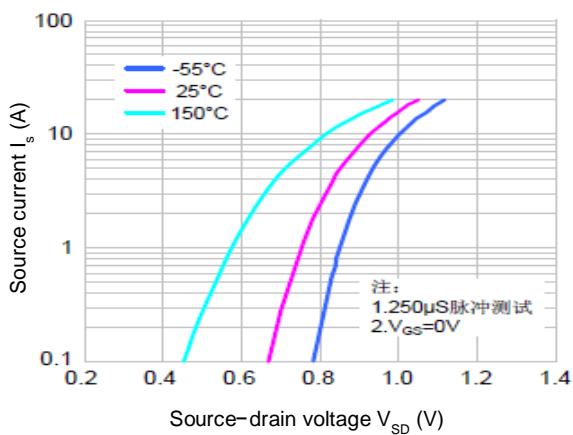


Figure 5. Source Current Variation vs. Source-drain Voltage

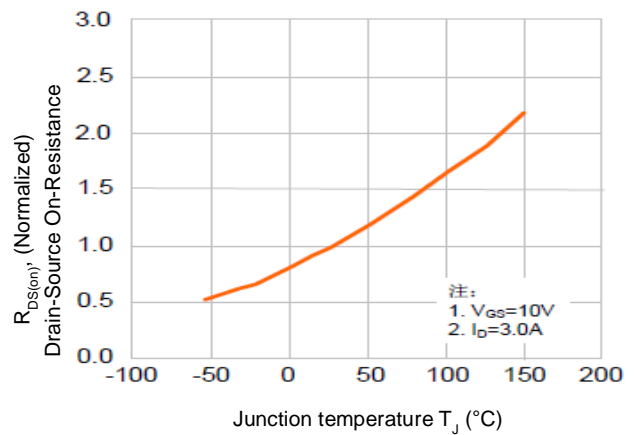


Figure 6. On-Resistance vs. Temperature

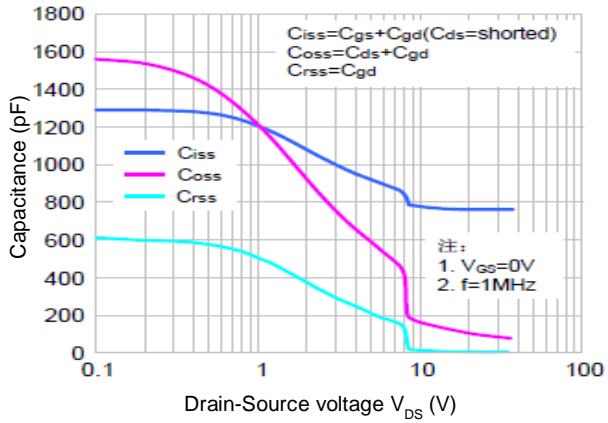


Figure 7. Capacitance Characteristics

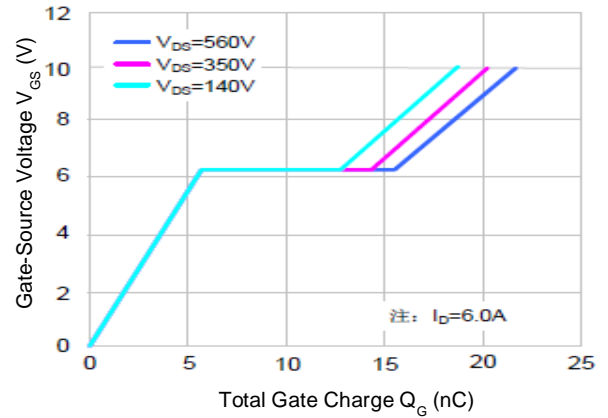


Figure 8. Gate Charge Characteristics

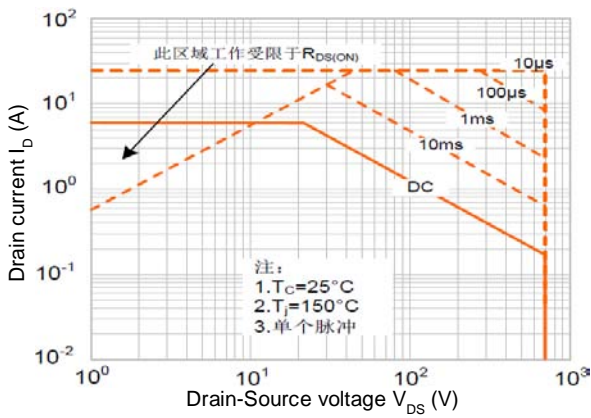


Figure 9. Maximum Safe Operating Area

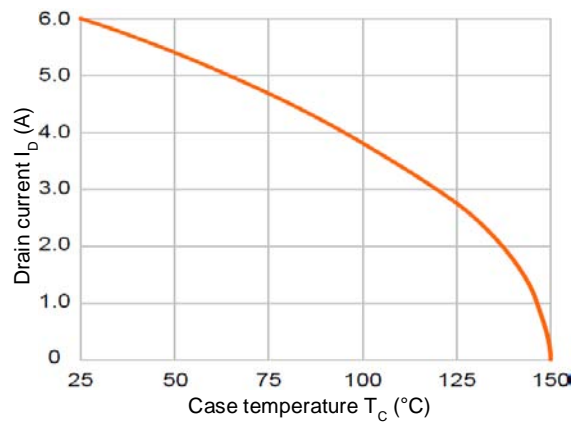
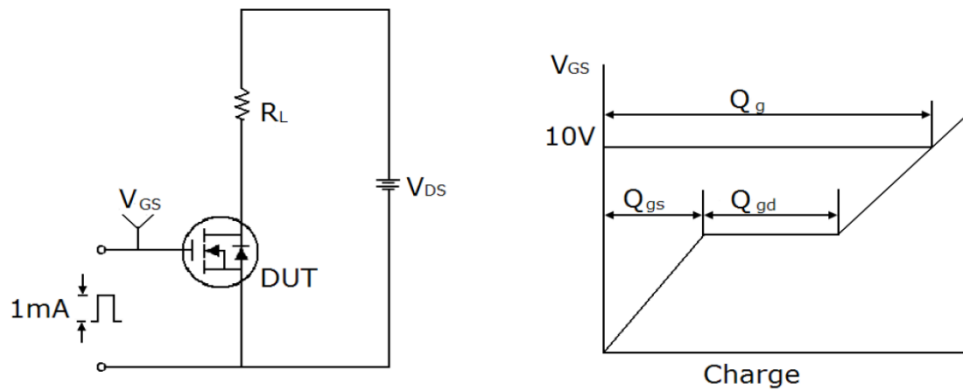
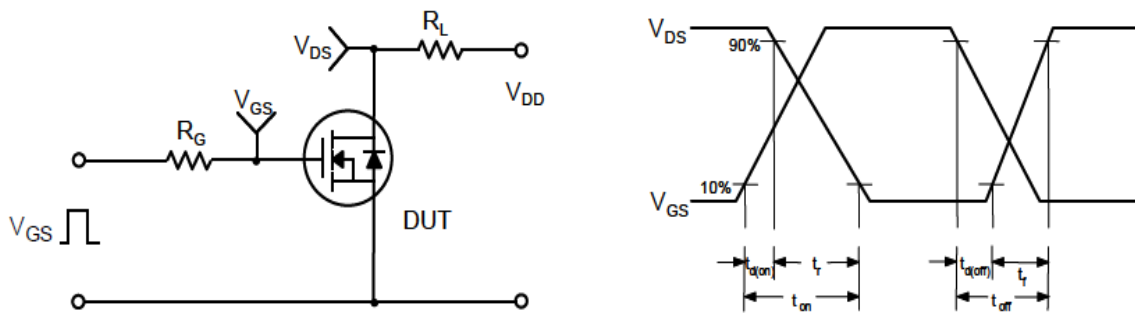


Figure 10. Drain Current vs. Case Temperature

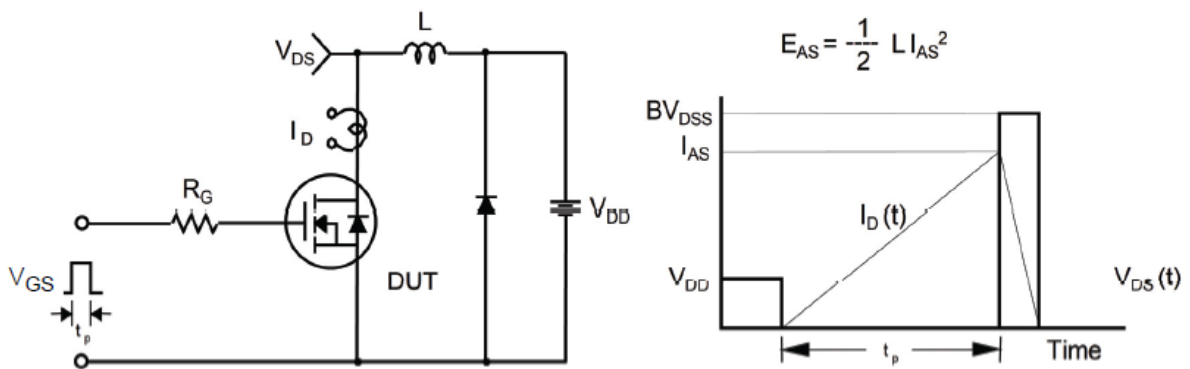
Gate Charge Test Circuit & Waveform



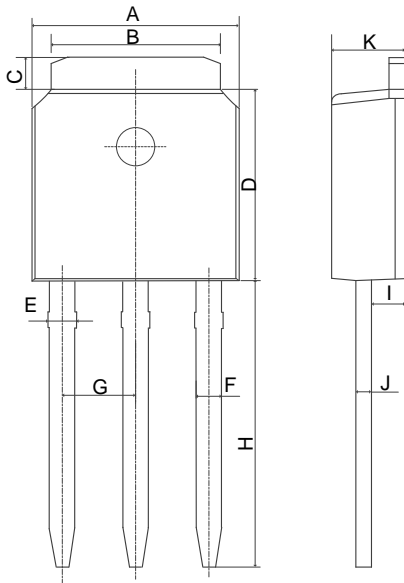
Switching Test Circuit & Waveforms



Unclamped Inductive Switching Test Circuit & Waveforms



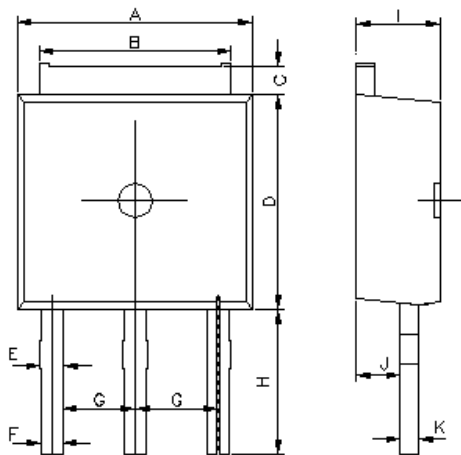
Mechanical Dimensions for TO-251



COMMON DIMENSIONS

SYMBOL	MM	
	MIN	MAX
A	6.40	6.80
B	5.13	5.46
C	0.90	1.25
D	5.90	6.20
E	0.80	1.00
F	0.71	0.91
G	2.19	2.39
H	9.00	9.60
I	0.90	1.10
J	0.40	0.60
K	2.10	2.50

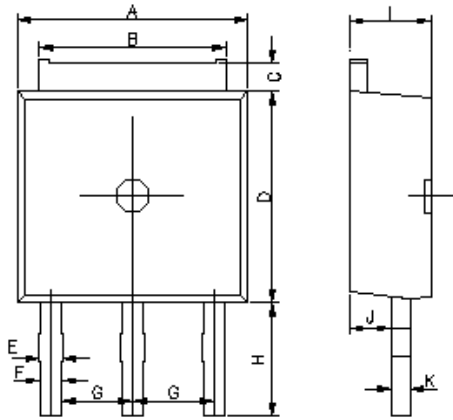
Mechanical Dimensions for TO-251S3



COMMON DIMENSIONS

SYMBOL	MM	
	MIN	MAX
A	6.40	6.80
B	5.18	5.48
C	0.75	1.02
D	5.95	6.35
E	0.70	1.00
F	0.70	0.90
G	2.14	2.44
H	3.30	3.70
I	2.10	2.50
J	0.85	1.15
K	0.41	0.61

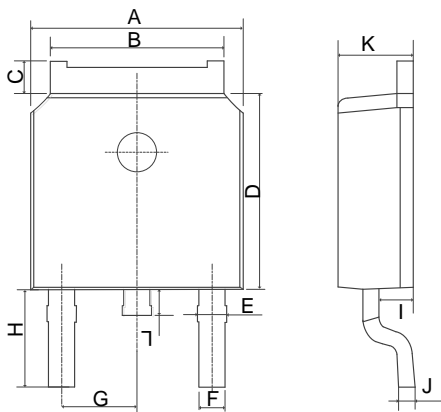
Mechanical Dimensions for TO-251S2



COMMON DIMENSIONS

SYMBOL	MM	
	MIN	MAX
A	6.40	6.80
B	5.18	5.48
C	0.75	1.02
D	5.95	6.35
E	0.70	1.00
F	0.70	0.90
G	2.14	2.44
H	2.30	2.70
I	2.10	2.50
J	0.85	1.15
K	0.41	0.61

Mechanical Dimensions for TO-252



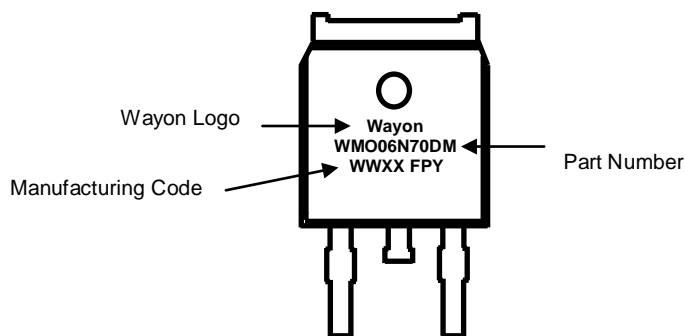
COMMON DIMENSIONS

SYMBOL	MM	
	MIN	MAX
A	6.40	6.80
B	5.13	5.46
C	0.90	1.25
D	5.90	6.20
E	0.80	1.00
F	0.71	0.91
G	2.19	2.39
H	2.60	3.10
I	0.90	1.10
J	0.40	0.60
K	2.10	2.50
L	0.60	1.00

Ordering Information

Part	Package	Marking	Packing method	Quantity
WMO06N70DM	TO-252	WMO06N70DM	Tape and Reel	2500
WMP06N70DM	TO-251	WMP06N70DM	Tube	80
WMH06N70DM	TO-252S2	WMH06N70DM	Tube	80
WMG06N70DM	TO-251S3	WMG06N70DM	Tube	80

Marking Information



Contact Information

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